TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

2SC5092

VHF~UHF Band Low Noise Amplifier Applications

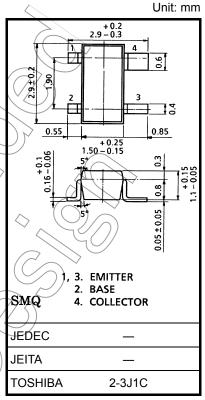
- Low noise figure, high gain.
- NF = 1.8dB, $|S_{21e}|^2 = 9.5dB$ (f = 2 GHz)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V_{CBO}	20	V
Collector-emitter voltage	V _{CEO}	10	V
Emitter-base voltage	V _{EBO}	1.5	\mathcal{C}_{I}
Base current	ΙΒ	20	mA ^
Collector current	IC	40	(MA)
Collector power dissipation	PC	150	mW
Junction temperature	Tj	125)C
Storage temperature range	T _{stg}	-55~125	> °C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions" Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Weight: 0.012 g (typ.)

Microwave Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Transition frequency	fr	V _{CE} = 8 V ₂ I _C = 20 mA	7	10	_	GHz
Incortion gain	S _{21e} ² (1)	V _{CE} = 8 V, I _C = 20 mA, f = 1 GHz	12	15	_	dB
Insertion gain	S _{21e} ² (2)	V _{CE} = 8 V, I _C = 20 mA, f = 2 GHz	= 20 mA, f = 2 GHz 6.5 9.5 —			T UB
Noise figure	NE (1)	$V_{CE} = 8 \text{ V}, I_{C} = 5 \text{ mA}, f = 1 \text{ GHz}$	_	1.4	2.5	dB
Noise ligure	NF (2)	$V_{CE} = 8 \text{ V}, I_{C} = 5 \text{ mA}, f = 2 \text{ GHz}$	_	1.8	3	uБ

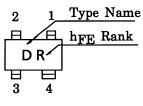
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I _{CBO}	$V_{CB} = 10 \text{ V}, I_{E} = 0$	_	_	1	μА
Emitter cut-off current	I _{EBO}	$V_{EB} = 1 \text{ V, } I_C = 0$	_	_	1	μА
DC current gain	h _{FE} (Note 1)	V _{CE} = 8 V, I _C = 20 mA	50	_	160	
Output capacitance	C _{ob}	V _{CB} = 10 V, I _E = 0, f = 1 MHz (Note 2)	_	0.7	1.1	pF
Reverse transfer capacitance	C _{re}	VCB = 10 V, 1E = 0, 1 = 1 IMIDZ (Note 2)		0.45	0.95	pF

Note 1: hFE classification R: 50~100, O: 80~160

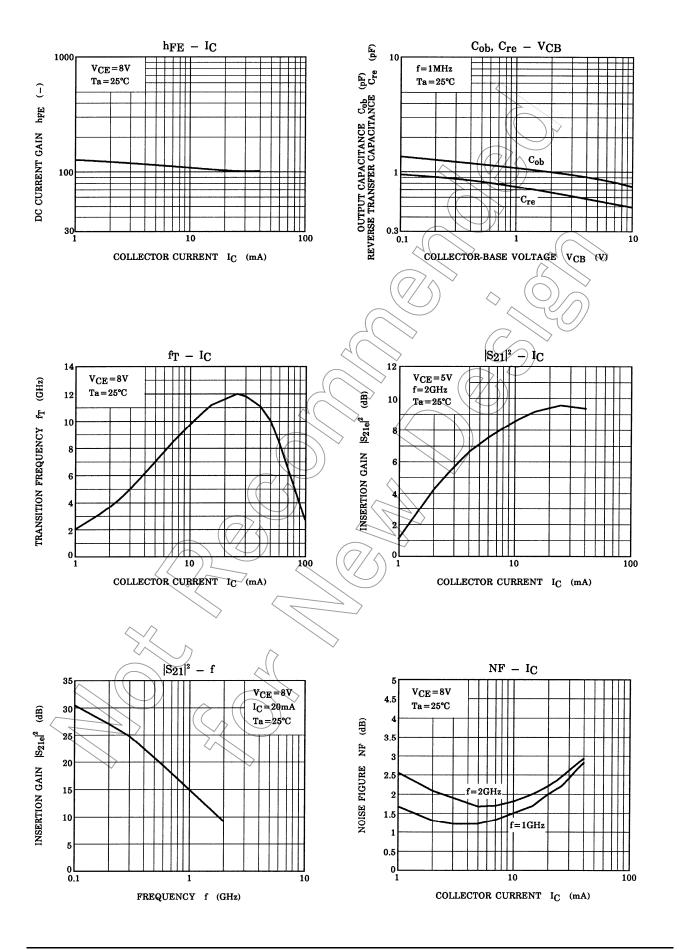
Note 2: C_{re} is measured by 3 terminal method with capacitance bridge.

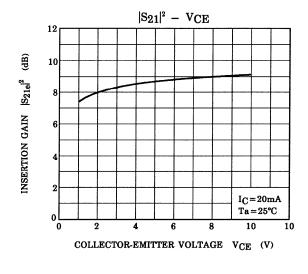
Marking

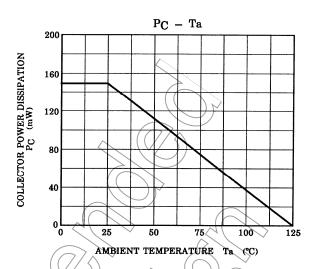




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S-Parameter $Z_O = 50 \Omega$, Ta = 25°C

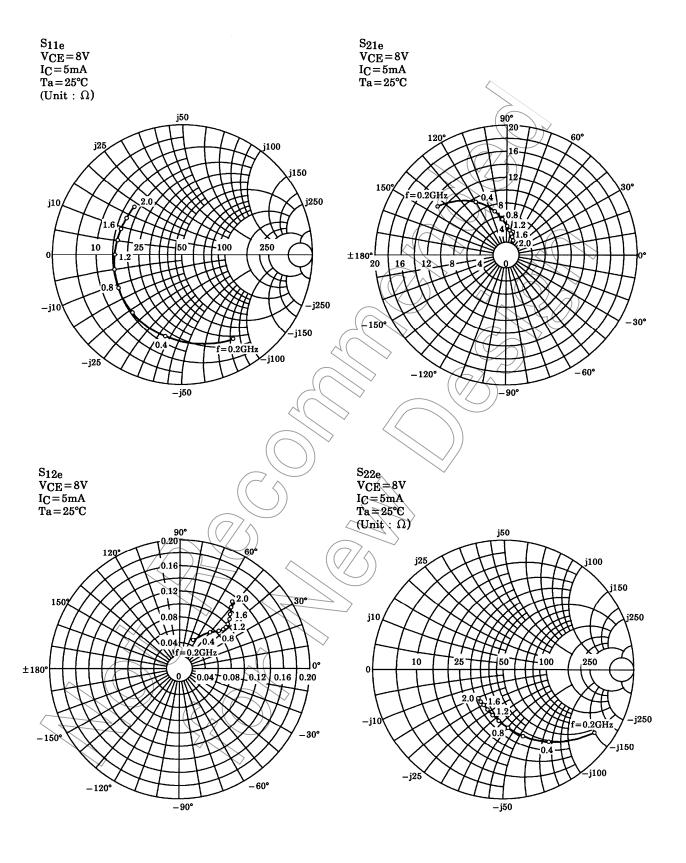
$V_{CE} = 8 V$, $I_C = 5 mA$

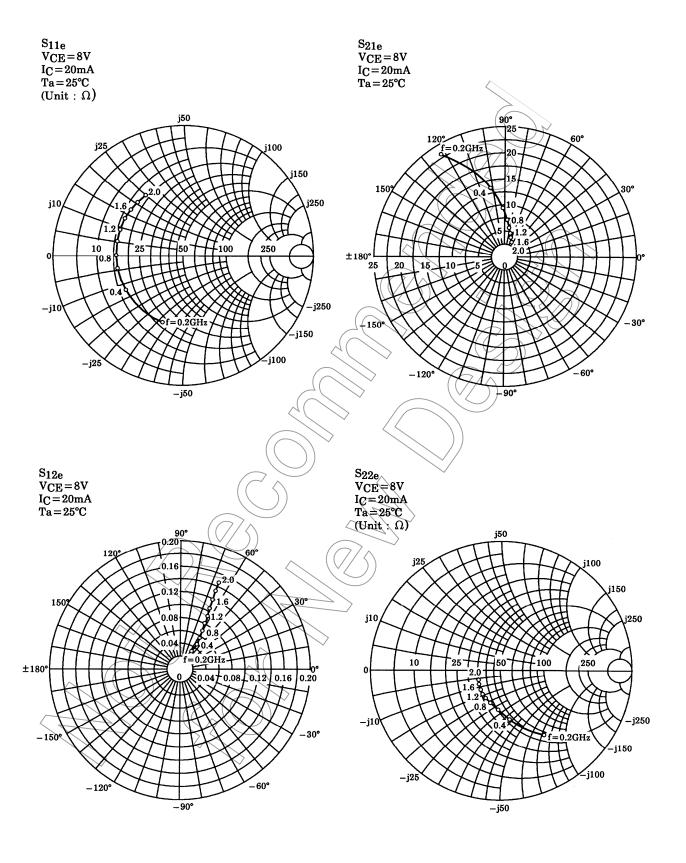
Frequency	S	11	S21		S	2	S	22
(MHz)	Mag.	Ang.	Mag.	Ang.	Mag.	(//Ang	Mag.	Ang.
200	0.767	-58.9	12.888	143.5	0.049	62.8	0.856	-34.5
400	0.655	-102.2	9.480	119.3	(0.073	48.7	0.663	-57.5
600	0.605	-130.0	7.087	104.6	0.086	43.1	0.535	-72.7
800	0.567	-150.4	5.577	93.9	0.093	40.7	0.456	-84.3
1000	0.547	-166.4 ((4,548	86.0	0.098	41.1	0.407	-93.8
1200	0.533	-179.7	3.798	79.3	0.103	42.5	0.373	-102.4
1400	0.528	169.1	3.268	76.9	0.109	44.1	0.346	-110.3
1600	0.519	158.4	2.856	69.3	0.116	46.6	0.328	-117.4
1800	0.520	148.3	2.551	(65.1)	0.124	48.9	0.314	-123.0
2000	0.524	138.7	2.290	61.1	0.133	51.1	0.303	-128.3

$V_{CE} = 8 \text{ V, } I_{C} = 20 \text{ mA}$

Frequency		\$11	> S	21	S1	2	S2	22
(MHz)	Mag.	Ang.	√ (Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
200	0.540	-106.8	23.009	123.0	0.033	56.9	0.605	-57.8
400	0.521		13.445	102.7	0.045	54.9	0.392	-81.2
600	0.521	-167.1	9.277	92.8	0.057	57.9	0.309	-95.5
800	0.525	-178.9	7.029	85.7	0.069	60.0	0.271	-107.3
1000	0.526	-168.8	5.651	80.0	0.082	62.5	0.250	-117.9
1200	0.529	-158.7	4.688	75.6	0.094	63.4	0.236	-127.6
1400	0.531	-148.5	4.011	71.6	0.106	64.5	0.225	-136.2
1600	0.536	-140.4	3.531	68.1	0.119	65.1	0.214	-143.8
1800	0.539	-131.7	3.159	64.7	0.133	65.5	0.201	-149.8
2000	0.540	-122.8	2.842	61.8	0.147	65.7	0.190	-154.8

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